1747363-1 ✓ ACTIVE

Dynamic Series | Dynamic High Density Frame

TE Internal #: 1747363-1

Housing, Receptacle, Wire-to-Board, 12 Position, 5.2 mm [.204 in] Centerline, Crimp, 4 Row, Black, Mating Retention, Dynamic High

Density Frame
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Connectors > PCB Connectors > Wire-to-Board Connectors > Wire-to-Board Connector Assemblies & Housings



Connector Product Type: Housing

Connector & Housing Type: Receptacle

Connector System: Wire-to-Board

Number of Positions: 12

Centerline (Pitch): 5.2 mm [.204 in]

Features

Product Type Features

	ousing
Connector & Housing Type	eceptacle
Connector System Win	ire-to-Board
Sealable	0
Connector & Contact Terminates To Win	ire & Cable

Configuration Features

Number of Positions	12
Number of Rows	4

Termination Features

Mechanical Attachment

Mating Retention	With
Connector Mounting Type	Cable Mount (Free-Hanging)

Housing Features

Centerline (Pitch)	5.2 mm[.204 in]
Housing Color	Black

Dimensions



Row-to-Row Spacing	6.5 mm[.255 in]
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	Power & Signal

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUL 2021 (219) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

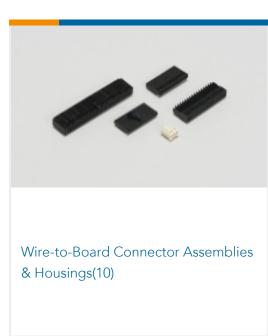
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





Also in the Series | Dynamic High Density Frame



Documents

Product Drawings

DYNAMIC D-3800 REC HSG 12P WITH HTS CONN

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1747363-1_D.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1747363-1_D.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1747363-1_D.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

1-1773732-4_DYNAMIC_SERIES_CATALOG_ENGLISH

Japanese

1-1773732-4_DYNAMIC_SERIES_CATALOG_ENGLISH

English

Product Specifications

Housing, Receptacle, Wire-to-Board, 12 Position, 5.2 mm [.204 in] Centerline, Crimp, 4 Row, Black, Mating Retention, Dynamic High Density Frame



Application Specification

English

Product Environmental Compliance

Product Compliance

English

Product Compliance

English